

GSGP1A thru GSGP7A

Surface Mount Glass Passivated Standard Rectifier Reverse Voltage 50-1000V Forward Current 1A

Features

- Low forward voltage drop
- Low leakage current
- Glass passivated Standard Rectifier
- Low profile typical height of 1.0 mm
- Moisture sensitivity: level 1, per J-STD-020
- H gh temperature soldering guaranteed: 260°C/10 seconds
- Halogen-free according to IEC 61249-2-21 definition

Typical Applications

For use of general purpose rectification in lighting, cellular phones, portable devices, power supplies and other consumer applications.

Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	GSGP1A	GSGP2A	GSGP3A	GSGP4A	GSGP5A	GSGP6A	GSGP7A	Unit
Maximum Repetitive Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	Vdc	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at TL (See Fig.1)	lf(AV)		1.0						
Peak Forward Surge Current (8.3 ms single half sine-wave superimposed on rated load)	IFSM		25						
Operating Junction and Storage Temperature Range	Tj, Tstg	- 55 to + 150							°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	SGP1A	SGP2A	SGP3A	SGP4A	SGP5A	SGP6A	SGP7A	Unit
Maximum Instantaneous Forward Voltage	1 A	V _F	1.1						V	
Maximum DC Reverse Current at rated DC Blocking Voltage	T _A =25°C T _A =125°C	I _R		5 50						μA
Typical Reverse Recovery Time	I _F =0.5A,I _R =1.0A, I _{rr} =0.25A	t _{rr}	1.8				μs			
Typical Junction Capacitance	4.0 V, 1 MHz	C _J 5		pF						
Typical Thermal Resistance ¹⁾	Juntion to Mount	R _{ejm}	55				°C/W			

Note:1)The thermal resistance from junction to ambient,case or mount,mounted on P.C.B with 5×5mm copper pads,2 OZ,FR4 PC



Package: eSGP (SOD-323F)



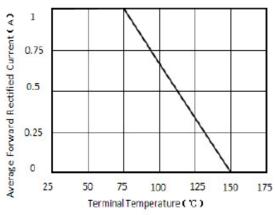


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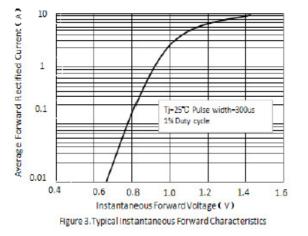
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Ratings and Characteristics Curves

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$







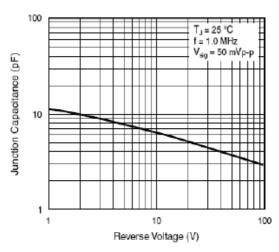
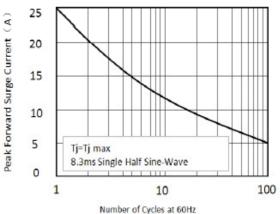
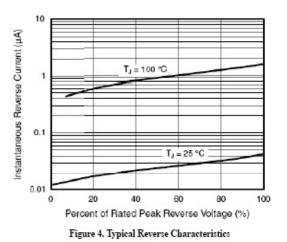


Figure 5. Typical Junction Capacitance







100 dounted on 0.20 x 0.27" (5 x 7 mm Copper Pad Area 10

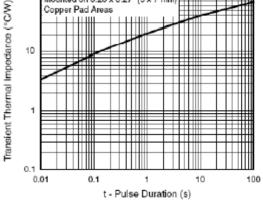


Figure 6. Typical Transient Thermal Impedance

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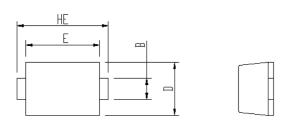


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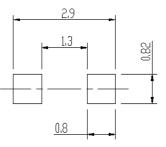
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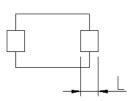
Package Outline Dimensions



Package	Unit	:mm	Unit:inch			
eSGP	MIN	MAX	MIN	MAX		
А	0.9	1.08	0.035	0.043		
В	0.5	0.7	0.020	0.028		
С	0.1	0.25	0.004	0.010		
D	1.4	1.6	0.055	0.063		
Е	2.0	2.2	0.079	0.087		
L	0.35	0.65	0.014	0.026		
HE	2.4	2.8	0.094	0.110		

Soldering footprint





Packing Information

Packing quantities:

3000 pcs/Reel, 40 Reels/Box; 8mm Tape, 7" Reel

Tape & Reel Specification

